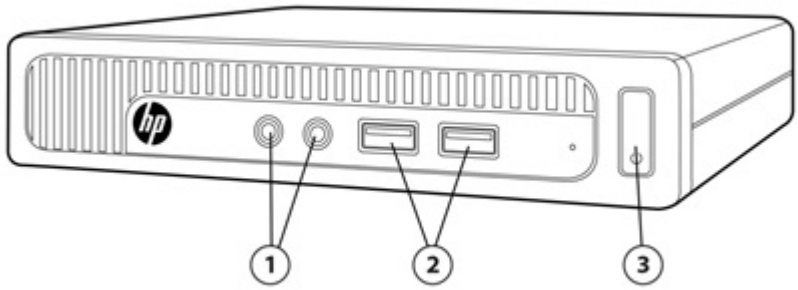
Overview

HP ProDesk 600 G1 Desktop Mini Business PC



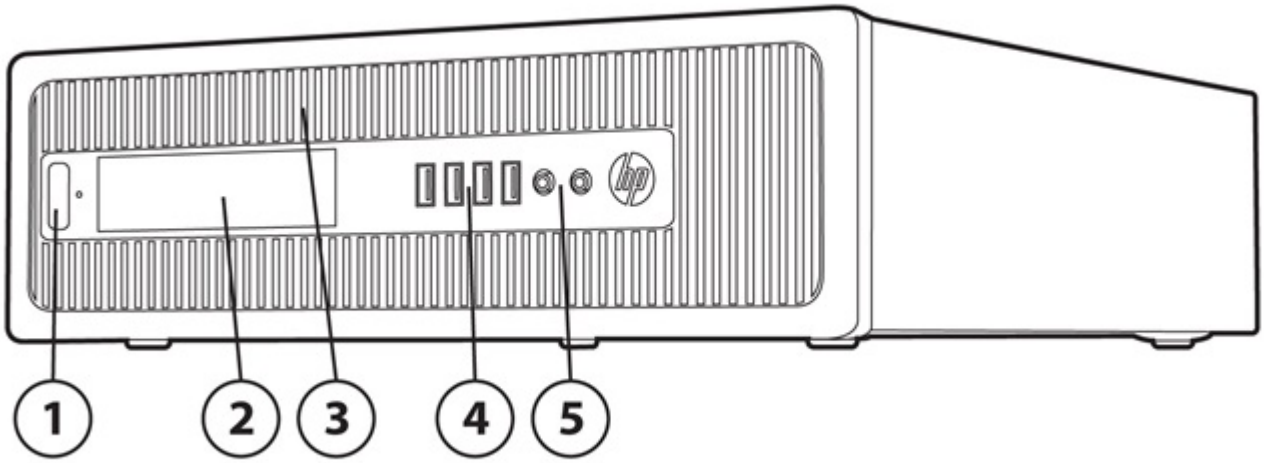
1. 3.5mm headphone output and microphone jacks
2. (2) Front USB 3.0 ports
3. Power button and PC status LED

Not Shown

Slots	(1) internal M.2 connector for optional wireless NIC (1) internal M.2 connector for optional SSD drive
Bays	(1) 2.5" internal storage drive bay
Rear I/O	(2) USB 3.0 ports; (2) USB 2.0 ports (1) VGA video port; (2) DisplayPort with multi-stream video ports (1) RJ-45 network connector 3.5mm audio out jack
VESA	Support for VESA 100mm mounting system on bottom of PC chassis

Overview

HP ProDesk 600 G1 Small Form Factor Business PC



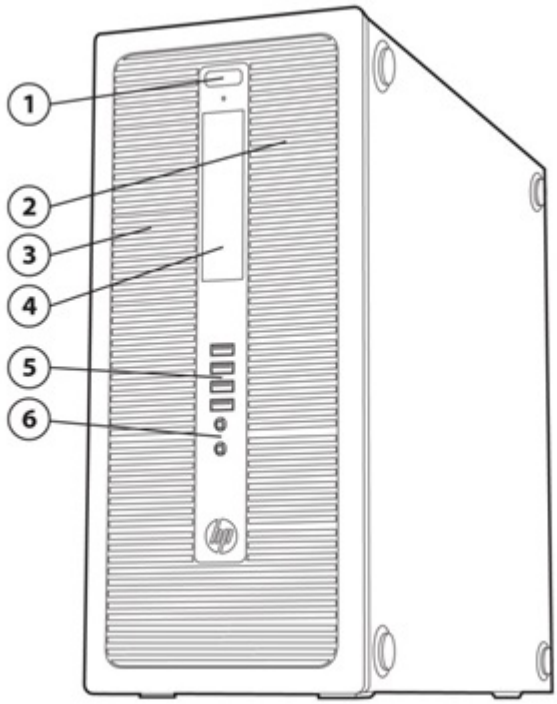
1. Power button and PC status LED
2. 3.5" external drive bay; used for installing a Media Card Reader or 2nd data storage drive
3. Slim drive bay supporting an optical disk drive (located behind removable bezel)
4. (2) USB 3.0 ports, (2) USB 2.0 ports
5. 3.5mm headphone output and microphone jack

Not Shown

Slots	(1) PCI Express x16 graphics connector (3) PCI Express x1 accessory connectors
Bays	(1) 2.5" internal storage drive bay (1) 3.5" internal storage drive bay
Rear I/O	(2) USB 3.0 ports; (4) USB 2.0 ports (1) VGA video port; (2) DisplayPort with multi-stream video ports (1) RJ-45 network connector (1) RS-232 serial port 3.5mm audio in/out jacks PS/2 keyboard and mouse ports

Overview

HP ProDesk 600 G1 Tower Business PC



1. Power button and PC status LED
2. Slim drive bay supporting an optical disk drive (located behind removable bezel)
3. 5.25" half height external drive bay (located behind removable bezel)
4. 3.5" external drive bay; used for installing a Media Card Reader
5. (2) USB 3.0 ports, (2) USB 2.0 ports
6. 3.5mm headphone output and microphone jack

Not Shown

Slots	(1) PCI Express x16 graphics connector (3) PCI Express x1 accessory connector
Bays	(1) 2.5" internal storage drive bay (2) 3.5" internal storage drive bay
Rear I/O	(2) USB 3.0 ports; (4) USB 2.0 ports (1) VGA video port; (2) DisplayPort with multi-stream video ports (1) RJ-45 network connector (1) RS-232 serial port 3.5mm audio in/out jacks PS/2 keyboard and mouse ports

Overview

At A Glance

- Choice of Desktop Mini, Small Form Factor or Tower chassis options
- PC chassis and all internal components and modules are manufactured with low halogen content
- HP developed and engineered UEFI BIOS supporting security, manageability and software image stability
- Intel® Q85 chipset supporting Intel 4th generation Core processors, featuring integrated Intel HD Graphics and Intel® Standard Manageability Technology
- Intel® Ethernet Connection I217L GbE LOM integrated network connection
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Multi-independent monitor support via VGA and dual digital DisplayPort video interfaces with multi-stream
- Discrete graphics options available for SFF and TWR platforms
- DTS+ Sound audio management software
- Standard and high efficiency energy saving power supply options
- ENERGY STAR® qualified and certified EPEAT® Gold models
- Guaranteed lengthy purchase lifecycles and image stability

Standard Features and Configurable Components (availability may vary by country)

OPERATING SYSTEM

Preinstalled When Purchased

Windows 8.1 Pro (64-bit)*
Windows 8.1 (64-bit)*
Windows 7 Ultimate (32-bit)**
Windows 7 Ultimate (64-bit)**
Windows 7 Professional (32-bit)**
Windows 7 Professional (64-bit)**
Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)***
Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)***
Windows 7 Home Premium (32-bit)**
Windows 7 Home Premium (64-bit)**

FreeDOS 2.0
Novell SUSE Linux Enterprise Desktop 11

*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows 7 Professional software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

CHIPSET

	DM	SFF/TWR
Intel® Q85 Express	X	X

PROCESSOR

	DM	SFF/TWR
Intel® 4th Generation Core™ i7 Processors		
Intel® Core™ i7-4765T Processor Up to 3.0 GHz Max. Turbo Frequency (2.0 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® Stable Image Platform Program (SIPP)	X	

Standard Features and Configurable Components (availability may vary by country)

Intel® Core™ i7-4770 Processor Up to 3.9 GHz Max. Turbo Frequency (3.4 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® Stable Image Platform Program (SIPP)		X
Intel Core i7-4771 Processor Up to 3.9 GHz Max. Turbo Frequency (3.5 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vProTM Technology and Intel® Stable Image Platform Program (SIPP)		X
Intel® 4th Generation Core™ i5 Processors		
Intel® Core™ i5-4570 Processor Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® Stable Image Platform Program (SIPP)		X
Intel® Core™ i5-4570T Processor Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency) 4 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® Stable Image Platform Program (SIPP)	X	
Intel® Core™ i5-4670 Processor Up to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® Stable Image Platform Program (SIPP)		X
Intel® 4th Generation Core™ i3 Processors		
Intel® Core™ i3-4130 Processor Up to 3.4 GHz base frequency 3 MB cache, 2 cores, 4 threads Intel HD Graphics 4400 Supports DDR3 memory up to 1600 MT/s data rate		X
Intel® Core™ i3-4130T Processor 2.9 GHz base frequency 3 MB cache, 2 cores, 4 threads Intel HD Graphics 4400 Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i3-4330 Processor Up to 3.5 GHz base frequency 4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate		X

Standard Features and Configurable Components (availability may vary by country)

Intel® Core™ i3-4330T Processor 3.0 GHz base frequency 4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i3-4340 Processor Up to 3.6 GHz base frequency 4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate		X
Intel® 4th Generation Pentium™ Processors		
Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate		X
Intel® Pentium™ G3220T Processor 2.6 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate	X	
Intel® Pentium G3420 Processor Up to 3.2 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		X
Intel® Pentium™ G3420T Processor 2.7 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Pentium G3430 Processor Up to 3.3 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		X
Intel® 4th Generation Celeron™ Processors		
Intel® Celeron™ G1820 Processor 2.7 GHz base frequency 2 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate Available February '14		X
Intel® Celeron™ G1820T Processor 2.4 GHz base frequency 2 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate	X	

Standard Features and Configurable Components (availability may vary by country)

Intel® Celeron™ G1830 Processor 2.8 GHz base frequency 2 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate Available February '14	X

GRAPHICS

	DM	SFF/TWR
Intel HD Graphics on all models (integrated on processor)	**X**	**X**
Optional Discrete Graphics Solutions		
AMD Radeon HD 8350 (1GB) PCIe x16		**X**
AMD Radeon HD 8490 (1GB) PCIe x 16		**X**
NVIDIA NVS 310 (512 MB) PCIe x16		**X**
NVIDIA NVS 315 (1GB) PCIe x 16		**X**
NVIDIA GeForce GT630 (2 GB) FH PCIe x16		**TWR only**
Adapters and Cables		
HP DMS-59 to Dual DisplayPort Cable		**X**
HP DMS-59 to Dual DVI Cable		**X**
HP DMS-59 to Dual VGA Cable		**X**
HP DisplayPort to DisplayPort Cable	**X**	**X**
HP DisplayPort to DVI-D Adapter	**X**	**X**
HP DisplayPort to HDMI Adapter	**X**	**X**
HP DisplayPort to VGA Adapter	**X**	**X**
HP Serial Port Adapter		**X**
HP Parallel Port Adapter		**X**

Standard Features and Configurable Components (availability may vary by country)

STORAGE

Hard Disk Drive (HDD)	DM	SFF/TWR
320 GB 7200 rpm HDD		X
500 GB 7200 rpm HDD	X	X
500 GB 7200 rpm SED HDD	X	X
500 GB 10K rpm HDD		X
1 TB 7200 rpm HDD		X
1 TB 10K rpm HDD		X
2 TB 7200 rpm HDD		X
Solid State Hybrid Drives (SSHD)		
500 GB SSHD (8 GB cache)	X	X
1 TB SSHD (8 GB cache)	X	X
Solid State Drives (SSD) & Self-encrypting Solid State Drives (SED)		
120 GB Opal SED	X	X
128 GB SSD		X
128 GB Opal SED	X	X
128 GB M.2 PCIe SSD	X	
160 GB SSD		X
180 GB Opal SED	X	X
256 GB SED		X
256 GB Opal SED	X	X
Optical Disc Drives		
Slim DVD-ROM		X
Slim BDXL Blu-ray Writer		X
Slim SuperMulti DVD Writer		X
HH Supermulti ODD		TWR only
Removable		
HP Slim Removable SATA HDD Frame/Carrier		X

Standard Features and Configurable Components (availability may vary by country)

MEMORY

Form Factor	Type	Maximum	# of Slots
Desktop Mini	DDR3 non-ECC up to 1600 MT/s	16 GB	2 SODIMM
Small Form Factor	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM
Tower	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

NETWORKING/COMMUNICATIONS

Ethernet (RJ-45)	DM	SFF/TWR
Intel I217LM Gigabit Network Connection (standard)	X	X
Intel Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)		X
Wireless		
Intel Centrino Advanced-N 6205 802.11 a/b/g/n PCI Express x1 Wireless Network Connection (optional)		X
Intel Wireless-N 7260 802.11 M.2 a/b/g/n NIC Card Wireless Network Connection (optional)	X	
Intel Wireless-N 7260 802.11 a/b/g/n PCIe x1 NIC Wireless Network Connection (optional)		X

AUDIO/MULTIMEDIA

Audio	DM	SFF/TWR
HD audio with Realtek ALC221 codec (all ports are stereo)	X	X
DTS Sound + audio management technology	X	X
Microphone* and headphone front ports (3.5mm)	X	X
Line-out and Line-In rear Ports* (3.5mm)	Line out only	X
Multi-streaming capable*	X	X
Internal speaker (standard)	X	X

* The front microphone port is re-taskable as a Line-in, Microphone-in or Headphone-out port. Rear audio input ports are re-taskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.

Standard Features and Configurable Components (availability may vary by country)

KEYBOARDS AND POINTING DEVICES

Keyboard	DM	SFF/TWR
HP PS/2 Keyboard		X
HP USB Keyboard	X	X
USB Smart Card (CCID) Keyboard	X	X
HP USB and PS/2 Washable Keyboard	X	X
HP Wireless Keyboard and Mouse Combo*	X	X
*Keyboard contains 25% post-consumer recycled plastic material.		
Mice		
HP PS/2 Mouse		X
HP USB Mouse	X	X
HP USB 1000dpi Laser Mouse	X	X
HP USB and PS/2 Washable Mouse	X	X

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability - HP BIOS provides several technologies that help integrate the HP ProDesk 600 G1 Series Business PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Stability - HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.1
- Computrace agent - For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management - The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Acoustic performance - Industry leading acoustic emissions across the range of operating conditions.
- Serviceability - HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery - HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features

- Power-On password - Helps prevent an unauthorized user from powering on the system.
- Administrator password - Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) - Represents a significant innovation in power and configuration management, allowing operating systems and applications to manage power based on activity and usage. HP Elite models

Standard Features and Configurable Components (availability may vary by country)

use ACPI to provide power conservation features.

S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

SECURITY

	DM	SFF/TWR
Trusted Platform Module (TPM) 1.2	X	X
SATA port disablement (via BIOS)	X	X
Drive lock	X	X
Intel® Identify Protection Technology (IPT)[1]	X	X
Serial, parallel, USB enable/disable (via BIOS)	X	X
Optional USB Port Disable at factory (user configurable via BIOS)	X	X
Removable media write/boot control	X	X
Power-On password (via BIOS)	X	X
Setup password (via BIOS)	X	X
HP Chassis (1 bay) Security Kit		TWR only
Solenoid Hood Lock / Sensor		X
Support for chassis padlocks and cable lock devices	X	X

[1]Models configured with Intel Core processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP Client Security module

ENVIRONMENTAL & REGULATORY

ENERGY STAR® qualified models available

EPEAT® registered where applicable/supported. See www.epeat.net for registration status by country.

Low halogen (chassis, all internal components and modules)

TAA compliant

Standard Features and Configurable Components (availability may vary by country)

PORTS

I/O Ports - Standard	DM	SFF/TWR
USB 2.0	2 (rear)	2 (front); 4 (rear)
USB 3.0	2 (front); 2 (rear)	2 (front); 2 (rear)
Serial (RS-232)	N/A	1
PS/2	N/A	1 keyboard (purple) 1 mouse (green)
Audio	3.5mm headphone & combo jack (front) 3.5mm audio out jack (rear)	3.5mm headphone & combo jack (front) 3.5mm audio in & out jacks (rear)
Network Interface	1 RJ-45	1 RJ-45
I/O Ports - Optional	**DM**	**SFF/TWR**
2nd Serial (RS-232)	N/A	1
Parallel	N/A	1

SLOTS

	DM	SFF/TWR
PCI Express x1	N/A	3
PCI Express x16	N/A	1
M.2	1 ea. M.2-2230 (for WLAN) 1 ea. M.2-2280 (for storage drives)	N/A

BAYS

	DM	SFF/TWR
Media Card Reader	N/A	1
Slim Optical Disc Drive	N/A	1
3.5" internal storage drive	N/A	1 - SFF 1 - TWR
2.5" internal storage drive	1	1

Standard Features and Configurable Components (availability may vary by country)

SERVICE AND SUPPORT

On-site Warranty [1]: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day [2] service for parts and labor and includes free telephone support [3] 24 x 7. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.
NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
NOTE 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

OPERATING SYSTEMS

Preinstalled

Windows 8.1 Pro (64-bit)*
Windows 8.1 (64-bit)*
Windows 7 Ultimate (32-bit)**
Windows 7 Ultimate (64-bit)**
Windows 7 Professional (32-bit)**
Windows 7 Professional (64-bit)**
Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)***
Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)***
Windows 7 Home Premium (32-bit)**
Windows 7 Home Premium (64-bit)**
FreeDOS 2.0
Novell SUSE Linux Enterprise Desktop 11

For all Preinstalled operating systems HP provides Microsoft WHQL certified (where applicable) drivers on www.hp.com at the time of product announcement.

Web Support

Windows 7 Enterprise (32-bit or 64-bit)
Windows 8 (64-bit)
Windows 8 Pro (64-bit)*
Windows 8 Enterprise (64-bit)**

For all Supported operating systems HP performs testing of the OS, and makes available all HP value add software (OS dependent). Certified drivers are made available on www.hp.com within 30 days of product announcement.

Certified

Novell SUSE Linux Enterprise Desktop 11[1]
Red Hat Enterprise Linux 641

For all Certified operating systems HP will submit hardware to the operating system vendor for testing and certification. All drivers would be obtained from the operating system vendor, not supplied by HP. Certification will be posted by the operating system vendor.

Test & Document

Windows® Vista Enterprise (32-bit or 64-bit)
Windows® Vista Professional (32-bit or 64-bit)

For all Test & Document operating systems HP will perform functional testing of the operating system on the HP business PC platform. Any issues found will be documented in an Engineering Advisory and/or Service Advisory and posted to www.hp.com. HP will not develop or qualify any drivers or perform any integration testing.

*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows® 7 Professional software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

[1]The following features are not supported by Novell SUSE Linux Enterprise Desktop:

- Intel Gigabit CT Desktop NIC
- Broadcom NetXtreme Gigabit Ethernet Plus
- HP 16-in-1 Media Card Reader
- HP Client Security

- HP Blu-ray Writer playback of commercial movies
- DisplayPort video interface
- HP 2nd serial port adapter
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

The following features are not supported by Red Hat Enterprise Linux 64:

- TPM v1.2 embedded Security Chip
- Intel Gigabit CT Desktop NIC
- HP Wireless 802.11b/g/n NIC
- HP 16-in-1 Media Card Reader
- HP Blu-ray Writer
- HP 2nd serial port Adapter
- HP USB Smart Card (CCID) Keyboard
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

SSOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Included	Windows 7	Windows 8.1
Security	Computrace (status tracing)[1] Device Access Manager Drive Encryption[4] File Sanitizer (Activated via Wizard) Disk Sanitizer (external version)[2] Microsoft Security Essentials HP Client Security	Computrace (status tracing) [1] Device Access Manager Drive Encryption[4] File Sanitizer (Activated via Wizard) Disk Sanitizer (external version)[2] Microsoft Defender Secure Erase HP Client Security
MultiMedia	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)
Communication		HP Wireless Hotspot
HP Value Add	HP ePrint Driver[3] HP PageLift HP Support Assistant HP Recovery Disk Creator	HP ePrint Driver[1] HP PageLift HP Recovery Manager HP Support Assistant HP QuickStart
3rd Party	Adobe Flash Player Bing Search for Internet Explorer 10 Box PDF Complete, Corporate Edition Skype	Bing Search PDF Complete, Corporate Edition Skype
Microsoft Products	Buy Office	Buy Office

[1] Computrace agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging from one to five years. Service is limited, check with Absolute for availability outside the U.S.

[2] Available via download

[3] Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter).Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary

[4] Drive Encryption is planned to be available in October 2013. Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.

Intel HD Graphics

VGA Controller	Integrated
DisplayPort	Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream Technology for a maximum of 3 displays (including the integrated panel)
Bus Type	N/A
RAMDAC	N/A
Memory	Intel graphics do not have dedicated memory but utilizes some of the computer's system memory The amount of memory used for graphics depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected video content. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.
Maximum Graphics Memory	Microsoft Windows 7: Up to 1.7GB Windows 8.1: Up to 1.8GB **NOTE:** The actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.
Maximum Color Depth	32 bits/pixel

Graphics/Video API Support	4th Generation Core processors:
	• The Processor Graphics contains a refresh of the seventh generation graphics core enabling substantial gains in performance and lower power consumption. Up to 16 EU support.
	• Next Generation Intel Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience
	  ○ Encode/transcode HD content
	  ○ Playback of high definition content including Blu-ray Disc
	  ○ Superior image quality with sharper, more colorful images
	• DirectX Video Acceleration (DXVA) support for accelerating video processing
	  ○ Full AVC/VC1/MPEG2 HW Decode
	• Advanced Scheduler 2.0, 1.0
	• Windows 7, Windows 8, Linux OS Support
	• DirectX 11.1
	• OpenGL 4.0
	• Open CL 1.2

Supported Display Resolutions and Refresh Rates

NOTE: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Technical Specifications - Graphics

Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1152x864	60 Hz
1280x600	60 Hz
1280x720	60 Hz
1280x800	60 Hz
1280x960	60 Hz
1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
1920x1440*	60 Hz
2560x1440*	60 Hz
2560x1600*	60 Hz

* Only supported on displays connected to the external DisplayPort connector.

AMD Radeon HD 7650A Graphics Card

Form Factor	MXM 3.0
Graphics Controller	AMD Radeon HD 7650A
Core Clock	600MHz
Memory Clock	800MHz
Memory	2GB, DDR3, 128-bit wide
Bus Type	MXM
Max. Power	35W
Power Source Support	12V and 19V
3D API Support	DX11, SMS
HDCP Support	Yes
Display Max. Resolution	Digital 2560 x 1600 Analog 2048 x 1536
Supported Graphics APIs	DX11, OpenGL, full 1080p BD (H264) playback in hardware, Multi-Stream DisplayPort support

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rates
800 x 600	60 Hz
1024 x 768	60 Hz
1280 x 720	60 Hz
1280 x 768	60 Hz
1280 x 1024	60 Hz
1360 x 768	60 Hz
1440 x 900	60 Hz
1600 x 900	60 Hz
1680 x 1050	60 Hz
1920 x 1080	60 Hz

NVIDIA NVS 310 Graphics Card

Introduction

The NVIDIA® NVS™ 310 Graphics Card is a PCI Express low profile form factor graphics add-in card targeted as an active low cost graphics solution for the corporate business and enterprise markets.

The NVIDIA® NVS 310 graphics card is an ideal solution for customers requiring a small form factor graphics add-in card for either standard or small form factor PC designs.

Performance and Features

The NVIDIA® NVS 310 Graphics Card offers 512 MB of ultrafast DDR3 memory and is capable of supporting up to 2 displays.

DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.

For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.

Form Factor

Low Profile: 2.713 × 6.15 in

Graphics Controller

NVIDIA® NVS 310

Memory Clock

875MHz

Memory Size

512 MB DDR3

Memory Bandwidth

14 GB/s

Max. Power

19.5W

Display Max. Resolution

Up to 2560 x 1600 (digital display) per display

Display Output

Up to 2 displays in the following configurations

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort Multi-Stream topology technology.

Technical Specifications - Graphics

DVI-D output:	• Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors • Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors
HDMI output:	• NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors
VGA display output:	• Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort
640 x 480	85	60	60	60
800 x 600	85	60	60	60
1024 x 768	85	60	60	60
1280 x 720	85	60	60	60
1280 x 1024	85	60	60	60
1440 x 900	75	60	60	60
1600 x 1200	60	60	60	60
1680 x 1050	60	60	60	60
1920 x 1080	60-R	60-R	60	60
1920 x 1200	60-R	60-R		60
1920 x 1440				60
2048 x 1536				60
2560 x 1600				60

NVIDIA GeForce GT630 Graphics Card

Introduction

The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Card Graphics Card provides a full height, PCI Express x16 graphics add-in card solution based on the NVIDIA Kepler Architecture GPU. The card is designed to support three display connections through its DVII, and two DisplayPort connectors.

An ideal solution for desktop PC customers seeking enhanced 2D and advanced 3D graphics performance, the NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards are an excellent choice for business users who want run multiple displays from a single graphics board. Engage in Web conferencing or video or photo editing, while improving your everyday business PC experience with better graphics and excellent visual display quality.

Performance and Features

The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards deliver superior PCI Express (PCIe) Gen 3 features including:

- Unprecedented flexibility for new applications and enhanced performance
- Support for NVIDIA surround technology
- Run multiple displays from a single graphics card
- Full 16 lane PCIe Generation 3 bus support with peak bandwidth support
- Wireless Display ready for future support

Form Factor	PCIe x16 Card
Graphics Controller	NVIDIA Kepler Architecture GPU
Core Clock	875 MHz
Memory Clock	891 MHz
Memory Size	2 GB DDR3 128 bit
Memory Bandwidth	28.5 GB/s
Display Max. Resolution	2560 x 1600 digital, 2048 x 1536 analog
Display Output	Integrated 400 MHz RAMDAC

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz)	
	Analog Connection	Digital Connection
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	60
2048 x 1536	75	60

2560 x 1600	N/A	60

NVIDIA NVS 315 1GB PCIe x 16 Graphics Card

Introduction	Get efficient dual-display graphics performance in a PCI Express low-profile graphics card with the NVIDIA NVS 315 PCIe x16 1 GB Graphics Card, an ideal desktop graphics solution for professional business and commercial applications.
Performance and Features	The NVIDIA® NVS 315 Graphics Card offers 1 GB of ultrafast DDR3 memory and is capable of supporting up to 2 displays. DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA. For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.
Form Factor	Low Profile: 2.713 × 6.15 in
Graphics Controller	NVIDIA® NVS 315
Memory Clock	875MHz
Memory Size	512 MB DDR3
Memory Bandwidth	14 GB/s
Connectors	DMS-59 , with support for dual VGA, dual DVI or dual Display Port with the appropriate adapter cable
Display Max. Resolution	Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 1600 DisplayPort
Display Output	Up to 2 displays in the following configurations

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	**Maximum Refresh Rates (Hz) by Connection**	
	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A

2560 x 1440	N/A	60*
2560 x 1600	N/A	60*

* Display Port Only

AMD Radeon HD 8350 1GB PCIe x16 DH Graphics Card

Introduction	Get stable 2D and advanced 3D graphics performance from the AMD Radeon HD 8350 1 GB PCIe x16 DH Graphics Card, a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8350 GPU, great for Web conferencing or video and photo editing.
Form Factor	PCie x16
Graphics Controller	AMD Radeon HD 8350
Core Clock	GPU engine operates at 523 MHz
Memory	1GB, DDR3, SDRAM
Memory Clock	875 MHz
HDCP Support	Yes
Display Max. Resolution	Digital 1920 x 1200 Analog 2048 x 1536

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	N/A
2560 x 1600	N/A	N/A

Technical Specifications - Graphics

AMD Radeon HD 8490 1GB PCie x16 Graphics Card

Introduction	Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8490 Graphics Processor. Improve your everyday PC, Web conferencing, and video or photo editing.
Form Factor	PCie x16
Graphics Controller	AMD Radeon HD 8490
Core Clock	GPU engine operates at 875 MHz
Memory	1GB, DDR3, SDRAM
Memory Clock	900 MHz
HDCP Support	Yes
Display Max. Resolution	Digital 2560 x 1600 Analog 2048 x 1536

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

	Analog Connection	Digital Connection
300 x 200	85	60
320 x 240	85	60
400 x 300	85	60
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 900	85	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60
2560 x 1600	N/A	60

Technical Specifications - Hard Disk and Solid State Storage

Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP ProDesk 600 G1 Series Business PC supports the latest SATA 6.0Gb/s specification.

HP Drive Lock

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

SMART IV Technology

Self Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

NOTE: GB = 1 billion bytes. Actual available capacity is less.

Technical Specifications - Hard Disk and Solid State Storage

HP 500-GB 7200 RPM SATA 2.5" Self-Encrypting (SED) Hard Disk Drive

Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Drive Type	Self-Encrypting Drive (SED) with SATA interface	
Interface	SATA Interface conforming to Serial ATA International Organization: Serial ATA Revision 2.6	
Segmented Buffer with write cache	32768 KB - A portion of buffer capacity used for firmware	
Number of Sectors	976,773,168	
Seek Time (typical reads)	Single Track:	1.0 ms
	Average:	13 ms
	Full-Stroke	25 ms
Media Diameter	2.5 in/63.5 mm	
Height	0.267 in/6.8 mm, ±0.2mm	
Width	2.75 in/69.85 mm, ±0.25mm	
Length	3.945 in/100.2 mm, ±0.25mm	
Weight	3.35 oz/95 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 1-TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity	1 TB	
Spindle Speed	5,400 rpm +/- 0.2%	
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash	
Interface	Serial ATA (SATA)	
Cache Buffer	64 MB	
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB	
Number of Sectors	976,773,168	
Seek Time (typical reads)	Single Track:	2.0 ms
	Average:	12 ms
Height	0.374 +/-.008 in (9.5 +/- 0.2 mm)	
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)	
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)	
Weight	0.254 lb/115 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

Technical Specifications - Hard Disk and Solid State Storage

HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity	500 GB	
Spindle Speed	5,400 rpm +/- 0.2%	
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash	
Interface	Serial ATA (SATA)	
Cache Buffer	64 MB	
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB	
Number of Sectors	976,773,168	
Seek Time (typical reads)	Single Track:	2.0 ms
	Average:	12 ms
Height	0.268 +/-.008 in (6.8 +/- 0.2 mm)	
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)	
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)	
Weight	0.209 lb/95 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 120 GB Solid State Drive

Unformatted Capacity	120 GB	
Architecture	Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller	
Interface	Serial ATA 2.0 (3.0 Gb/s)	
Dimensions (W x H x D)	2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)	
Weight	0.18 lb (80 g)	
Bandwidth Performance	Sustained Sequential Read:	Up to 250 MB/s
	Sustained Sequential Write:	Up to 70 MB/s
	Random Read:	Up to 35K IOPs
	Random Write:	Up to 6.6K IOPs
Latency	Read:	65-ms
	Write:	85-ms
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p
	Total power consumption:	0.15W (active); 0.075W (idle)
Useful Drive Life	35TB written, up to 20GB/day for 5 years	
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity:	5% to 95%
	Maximum Wet Bulb Temperature (operating):	84° F (29° C)
	Shock:	1,500 G/0.5-ms

* For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

Technical Specifications - Hard Disk and Solid State Storage

HP 128 GB Solid State Drive

Unformatted Capacity	128 GB*	
Architecture	Multi Level Cell (MLC) NAND	
Interface	SATA 6 GB/sec	
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)	
Weight	0.16 lb (73 g)	
Bandwidth Performance	Sustained Sequential Read:	Up to 450 MB/ss
	Sustained Sequential Write:	Up to 260 MB/s
	Random Read (4KB):	up to 46K IOPs
	Random Write (4KB):	up to 56K IOPs
Latency	Read:	55ms (TYP)
	Write:	55ms (TYP)
Power	DC power requirement:	Min 4.5 V; Max 5.5 V
	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)
Useful Drive Life	1.2 million device hours**	
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity (operating):	5% to 95%
	Shock:	1,500 G/1.0 msec
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark	

* For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 160 GB Solid State Drive

Unformatted Capacity	160 GB*	
Architecture	Multi Level Cell (MLC) NAND	
Interface	SATA 3 GB/sec	
Dimensions (W x H x D)	2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)	
Weight	0.18 lb (80 g)	
Bandwidth Performance	Sustained Sequential Read:	Up to 250 MB/s
	Sustained Sequential Write:	Up to 70 MB/s
	Random Read (4KB):	up to 35K IOPs
	Random Write (4KB):	up to 6.6K IOPs
Latency	Read:	65 ms
	Write:	85 ms
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p
	Total power consumption:	0.15 Watt (Active); 0.075 Watt (Idle)
Useful Drive Life	35TB written, up to 20GB/day for 5 years **	

Technical Specifications - Hard Disk and Solid State Storage

Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity (operating):	5% to 95%
	Shock:	1,500 G/1.0 msec
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark	

* For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content
** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive

Unformatted Capacity	256,186,209,271 bytes	
Architecture	Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface	
Interface	Serial ATA 2.0 (3.0 Gb/s)	
NAND Flash	25nm MLC NAND Flash	
Height	.275 in/7mm	
Width	2.75 in/69.85 mm	
Length	3.95 in/100.5 mm	
Weight	0.161 lb (73 g)	
Bandwidth Performance	Sustained Sequential 128k Read:	Up to 450 MB/ss
	Sustained Sequential 128k Write:	Up to 260 MB/s
	Random 4k Read:	up to 46K IOPs
	Random 4k Write:	up to 56K IOPs
Latency	Read:	55 µs
	Write:	55 µs
Power	SATA power consumption:	160 mW (active average); <85 mW (idle average)
Useful Drive Life	72TB written, up to 40GB/day for 5 years	
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity:	5% to 95%
	Shock:	1,500 G/1 ms

Technical Specifications - Hard Disk and Solid State Storage

HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	976,773,168	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	2.0 ms
	Average:	11 ms
	Full-Stroke:	21 ms
Height (nominal)	1 in/2.54 cm	
Width (nominal)	Media diameter: 3.5 in/8.89 cm Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	1,000,204,886,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)	
Buffer Size	32 MB	
Logical Blocks	1,953,525,168	
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	2.0 ms
	Average:	11 ms
	Full-Stroke:	21 ms
Height (nominal)	1 in/2.54 cm	
Width (nominal)	Media diameter: 3.5 in/8.89 cm Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	

Technical Specifications - Hard Disk and Solid State Storage

HP 2-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Unformatted Capacity	2 TB	
Rotational Speed	7,200 rpm	
Interface	SATA 6Gb/s NCQ	
Cache, Multisegmented (MB)	64 MB	
Seek Time (average)	Read	<8.5 ms
	Write	<9.5 ms
Height	1.028 in/26.11 mm	
Width	4.0 in/101.6 mm	
Depth	5.787 in/146.99 mm	
Weight	1.38 lb/626 g	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP Slim SuperMulti DVD Writer Drive

Height	12.7mm height	
Orientation	Either horizontal or vertical	
Interface type	SATA/ATAPI	
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB standard	
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel	
Weight (max)	0.42 lb (190 g)	
Write speeds	DVD-RAM	Up to 5X
	DVD-R DL	Up to 6X
	DVD+R	Up to 8X
	DVD+RW	Up to 8X
	DVD+R DL	Up to 6X
	DVD-R	Up to 8X
	DVD-RW	Up to 6X
	CD-R	Up to 24X
	CD-RW	Up to 24X
Read speeds	DVD-RAM	Up to 5X
	DVD-RW, DVD+RW	Up to 8X
	DVD-R DL, DVD+R DL	Up to 8X
	DVD+R, DVD-R	Up to 8X
	DVD-ROM DL, DVD-ROM	Up to 8X
	CD-ROM, CD-R	Up to 24X
	CD-RW	Up to 24X
Access time (typical reads, including settling)	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)
	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)
	Stop Time	6 seconds (typical)
Power	Source	Slimline SATA DC power receptacle
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p
	DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum)

Technical Specifications - Removable Storage

Environmental conditions (operating - non-condensing)	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
	Maximum Wet Bulb Temperature	84° F (29° C)

HP Slim Blu-ray BDXL Drive

Height	12.7mm Slim tray-load
Orientation	Either horizontal or vertical
Interface type	SATA/ATAPI
Disc capacity	Up to 128 GB QL, 100 GB TL, 50 GB DL or 25 GB standard SL
Dimensions W x H x D (max)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel
Weight (max)	Up to 0.37 lb (170 g) without bezel

Write speeds		**Triple-layer**	**Quadruple-layer**
	BD-R	Up to 4x	Up to 4x
	BD-RE	Up to 2x	Not supported
		Single-layer	**Double-layer**
	BD-R	Up to 6x	Up to 6x
	BD-RE	Up to 2x	Up to 2x
	DVD-R	Up to 8x	Up to 6x
	DVD-RW	Up to 6x	Not supported
	DVD+R	Up to 8x	Up to 6x
	DVD+RW	Up to 8x	Not supported
	DVD-RAM	Up to 5x	N/A
	CD-R	Up to 24x	N/A
	CD-RW	Up to 24x	N/A
Read speeds		**Triple-layer**	**Quadruple-layer**
	BD-R	Up to 4x	Up to 4x
	BD-RE	Up to 4x	Not supported
		Single-layer	**Double-layer**
	BD-ROM	Up to 6X	Up to 6X
	BD-R	Up to 6x	Up to 6x
	BD-RE	Up to 6x	Up to 6x
	DVD-ROM	Up to 8x	Up to 8x
	DVD-R	Up to 8x	Up to 8x
	DVD-RW	Up to 8x	Not supported
	DVD+R	Up to 8x	Up to 8X
	DVD+RW	Up to 8x	Not supported

Technical Specifications - Removable Storage

	BDMV (AACS Compliant Disc)	Up to 6x/2x (Read/Play)
	DVD-RAM	Up to 5x
	DVD-Video (CSS Compliant Disc)	Up to 8x/4x (Read/Play)
	CD-R/RW/ROM	Up to 24x
	CD-DA (DAE)	Up to 20x/10x (Read/Play)
Access times (typical reads, including setting)	**Random**	BD-ROM: 205 ms (typical), DVD-ROM: 185 ms (typical), CD-ROM: 165 ms (typical)
	Full Stroke	BD-ROM: 350 ms (typical), DVD-ROM: 345 ms (typical), CD-ROM: 340 ms (typical)
Power	**Source**	Slimline SATA DC power receptacle
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p
	DC Current	5 VDC -1200 mA typical, 2000 mA maximum
Environmental (all conditions non-condensing)	**Temperature** (operating)	41° to 122° F (5° to 50° C)
	Relative Humidity (operating)	10% to 80%
	Maximum Wet Bulb Temperature (operating)	84° F (29° C)

HP Slim DVD-ROM Drive

Height	12.7mm	
Orientation	Either horizontal or vertical	
Interface type	SATA/ATAPI	
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel	
Weight (max)	Up to 0.37 lb (170 g) without bezel	
Read speeds	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X
	DVD-ROM	Up to 8X
	CD-ROM, CD-R	Up to 24X
	CD-RW	Up to 24X
Access time (typical reads, including settling)	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)
	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)
Power	Source	Slimline SATA DC power receptacle
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum

Technical Specifications - Removable Storage

Environmental (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
	Maximum Wet Bulb Temperature (operating)	84° F (29° C)

System Memory Support

The HP ProDesk 600 G1 Business PC supports the 4th generation Intel® Core™ processor family. Based on a new PC micro-architecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the 4th generation Intel® Core™ processor includes an Integrated Memory Controller (IMC). The IMC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- Theoretical maximum memory bandwidth of:
  - 21.3 GB/s in dual-channel mode assuming 1333 MT/s
  - 25.6 GB/s in dual-channel mode assuming 1600 MT/s

Platform Memory Support

- The Small Form Factor (SFF) and Tower (TWR) platforms support up to four (4) industry-standard DDR3-SDRAM DIMMs.
- The Desktop Mini platform supports up to two (2) industry-standard DDR3-SDRAM SODIMMs.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Intel® I217LM GbE Network Connection (integrated)

Connector	RJ-45
System Interface	Integrated on PCA
Controller	Intel I217LM GbE platform LAN connect networking controller
Memory	24 KB FIFO packet buffer memory
Data rates supported	10/100/1000 Mbps
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3ab 802.3az 802.3u
Bus architecture	PCI Express and SMBus
Data transfer mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
Power requirement	Requires 3.3V and 0.9V or just 3.3V with integrated regulators Power consumption 0.733 Watts
Boot ROM support	Yes
Network transfer mode	Full-duplex Half-duplex (not supported for the 1000BASE-T transceiver)
Network transfer rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
Environmental	Operating Temperature: 0° to 85° C Operating Humidity: 60% RH
Management	WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic
Alerting	ASF 2.0 support; AMT 9.0 support

Technical Specifications - Networking and Communications

Intel® Ethernet I210-T1 Gigabit Network Adapter

Connector	RJ-45
System Interface	PCI Express x1
Controller	Intel® I210 Gigabit Ethernet Controller
Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers
Data rates supported	10/100/1000 Mbps
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3AB 802.3u 802.3x flow control
Bus architecture	PCI-E 2.1
Data path width	X1, 250 MB/s, Bi-directional interface
Data transfer mode	Bus-master DMA
Hardware certifications	FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European Union
Power requirement	Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T
Boot ROM support	Yes
Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)
Environmental	Operating Temperature: 32° to 131°F (0° to 55° C) Operating Humidity: 85% at 131° F (55° C)
Management	WOL, PXE, DMI, WFM 2.0

Intel Centrino Advance-N 6205 Wireless Network Interface Connection

Wireless LAN Standards	IEEE 802.11a/b/g/n IEEE 802.11 e, 802.11i, 802.11d, 802.11d, 802.11h
Interoperability	Wi-Fi certified (802.11 a/b/g/n WMM, WPA, WPA2 and WPS) Tested with wireless access points from several major manufacturers OS compatible with Microsoft Windows, Win7 and XP Cisco Compatible Extensions Program compliant (802.11a/b/g only) with Microsoft Windows XP and Windows 7
Frequency Band	2.4 GHz and 5 GHz
Antenna Structure	2 transmit; 2 receive (2x2)

Technical Specifications - Networking and Communications

Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n specification	
Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM	
Security	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128bits), TKIP, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, GTC Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows XP only.	
Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.	
Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) Intel® My Wifi Technology (iPAN)	
Roaming	Provide seamless roaming between like access points (same frequency band)	
Output Power (for CCK)	15 dBm	
Output Power (for OFDM; power varies by data rate)	15 dBm	
Power Consumption	Transmit: 2.3 Watts (average, with one spatial streams) Receive: 1.9 Watts (average with two receive chains) Idle mode: 30mW – 40mW (average) Radio off: 20 mW (max)	
Power Management	ACPI compliant power management 802.11 compliant power saving mode	
Antenna Connections	3 U.FL type connectors, 50 ohm nominal impedance	
Range	802.11 a - Typical (@6 Mbps)	600 feet - Outdoor Open Area 150 feet - Indoor, Office environment
	802.11 b - Typical (@1 Mbps)	1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment
	802.11 g - Typical (@1 Mbps)	1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment
Form Factors	CMIT & SFF:	PCIe
Weight	0.013 lb (4.0 g)	
Dimensions	1.1 x 1.2 in (26.8 x 30.0 mm)	
Operating Voltage	3.3V +/- 9%, 1.5V +/- 5%	
Temperature	**Operating:** **Non-operating:**	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)
Humidity	**Operating:** **Non-operating:**	10% to 90% (non-condensing) 5% to 90% (non-condensing)
	Microsoft Windows XP	Microsoft Windows Win 7

Technical Specifications - Networking and Communications

Configuration Utility	• Microsoft Windows XP Wireless Network Connection Manager • Intel PROSet for Microsoft Windows XP (required for Cisco Compatible Extensions support)	• Intel IHV extensions for Win7 available to support Cisco Compatible Extensions

Technical Specifications - Audio

High Definition Audio

Type	Integrated
HD Stereo Codec	Realtek 2-channel ALC221 codec
Audio I/O Ports	Front microphone-In (150-K ohm Input Impedance) Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio driver) Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load) Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load) Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven with the same signal. All ports are 3.5mm
Internal Speaker Amplifier	1.5W amplifier for the internal speaker only. External speakers must be powered externally. Rear Line-in audio port is re-taskable as either Line-in or Microphone-In.
Multi-streaming Capable	Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks.
Sampling	8 kHz - 192 kHz
Wavetable Syntheses	Yes – Uses OS soft wavetable
Analog Audio	Yes
# of Channels on Line-Out	Stereo (Left & Right channels)
Internal Speaker	Yes
External Speaker Jack	Yes
Full Duplex	Yes

HP USB Keyboard

	Keys	104, 105, 106, 107, 109 layout (depending upon country)
Physical characteristics	Dimensions (L x W x H)	18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm)
	Weight	2 lb (0.9 kg)
Electrical	Operating voltage	+ 5VDC ± 5%
	Power consumption	50-mA maximum (with three LEDs ON)
	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft® PC 99 - 2001	Functionally compliant
Mechanical	Keycaps	Low-profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
	Microsoft PC 99 - 2001	Mechanically compliant
Environmental	Acoustics	43-dBA maximum sound pressure level
	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	-22° to 140° F (-30° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	20% to 80% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces
	Operating vibration	2-g peak acceleration
	Non-operating vibration	4-g peak acceleration
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence
Approvals	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC	
Ergonomic compliance	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC	

Technical Specifications – Keyboards and Pointing Devices

Kit contents	Keyboard	Installation Guide
	Warranty Card	Safety and Comfort Guide

HP PS/2 Keyboard

Physical Characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
	Dimensions (L x W x H)	18.22 x 6.47 x 1.1 in (46.28 x 16.43 x 2.79 cm)
	Weight	2 lb (0.9 kg) minimum
Electrical	Operating voltage	+ 5VDC ± 5%
	Power consumption	50-mA maximum (with three LEDs ON)
	System interface	PS/2 6-pin mini din connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
Mechanical	Microsoft PC 99 - 2001	Functionally compliant
	Keycaps	Low-profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
	Microsoft PC 99 - 2001	Mechanically compliant
Environmental	Acoustics	50-dBA maximum sound pressure level
	Operating temperature	32° to 104° F (0° to 40° C)
	Non-operating temperature	-22° to 149° F (-30° to 65° C)
	Operating humidity	15% to 80% (non-condensing at ambient)
	Non-operating humidity	15% to 90% (non-condensing at ambient)
	Operating shock	N/A
	Non-operating shock	65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266 inch/second six surface
	Operating vibration	2-g peak acceleration

	Non-operating vibration	Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz and back to 5 Hz at a Logarithmic sweep rate of 1 octave per minute.
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	29.93 in (76 cm) on concrete, 16-drop sequence
Approvals	CUL, ICES-003 Class B, FCC, CE Mark,TUV GS, VCCI, BSMI, C-Tick, KC	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS	

HP USB Smart Card (CCID) Keyboard

Key Benefits:

- Protects against unauthorized access with smart card technology
- Delivers even greater security when combined with a HP ProtectTools smart card and the HP ProtectTools Security Software
- Combination of username and password or pin with a smart card or security token
- Secures online transactions using digital signatures and certificates
- Conforms to industry standards for ease of setup and use
- Delivers long product life and quiet operation with high-impact materials and lubricated keys
- Spill drain feature

Physical Characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country
	Form factor	USB basic smart card keyboard
	Colors	Carbonite/Silver
	Dimensions (H x W x D)	18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)
	Weight	2 lb (0.9 kg) minimum
Electrical	Operating voltage	+ 5VDC ± 5%
	Power consumption	100-mA maximum (with four LEDs ON)
	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC 99 - 2001	Functionally compliant
Mechanical	Languages	30+ available
	Keycaps	Standard design
	Switch actuation	55 g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
	Switch type	Contamination-resistant membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
	Microsoft PC 99 - 2001	Mechanically compliant
	Acoustics	43-dBA maximum sound pressure level
	Operating temperature	50° to 122° F (10° to 50° C)

Technical Specifications – Keyboards and Pointing Devices

Environmental	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	
	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	
SmartCard Function	Support	All ISO 7816 smart cards	
	Interface	Reads from and writes to all ISO7816-1, 2, 3, 4 memory and microprocessor smart cards (T=0, T=1)	
	Chipset	SCM STCIII	
	Standard APIs supported	PC/SC, EMV2000, CT-API	
	Power	USB Port	
		Short circuit detection (protects smart card and reader)	
		Power supply compliant with ISO7816 and EMV (5V, 60 mA)	
		Supports 3-V and 5-V cards	
	Power consumption	100-mA maximum draw	
	Communication	From card	9600 bps to 330,000 bps
		From computer	12 Mbps (USB transfer speed)
	Landing mechanism	Contact device	Friction contact
		Card insertions rating	Up to 100,000 insertion cycles
	Interface modes	CCID protocol	
	Reader performance interface	USB connection	
	Electro-magnetic standards	Europe	2004/108/EC
		USA	USAFCC part 15
Approvals	CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, USB-IF		
Ergonomic Compliance	ISO 9241-4, TUVGS		
Kit Contents	Keyboard, I/O Security and Documentation CD, warranty card		

HP USB PS/2 Washable Keyboard

Physical Characteristics	Keys	104 (US) layout or 105 (EU) layout – depending upon country
	Dimensions (L x W x H)	17.67x 6.62 x 1.38 in (449 x 168 x 35 mm)
	Weight	1.7 lb (0.77 kg) minimum
	Operating voltage	+ 5VDC ±5%

Technical Specifications – Keyboards and Pointing Devices

Electrical	Power consumption	50-mA maximum (with three LEDs ON)
	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft® PC 99 - 2001	Functionally compliant
Mechanical	Keycaps	Stepped -profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life	20 million keystrokes
	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	7 ft (2.2 m)
	Microsoft PC 99 - 2001	Mechanically compliant
Environmental	Acoustics	43-dBA maximum sound pressure level
	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	-22° to 140° F (-30° to 60° C)
	Operating humidity	10% to 95% (non-condensing at ambient)
	Non-operating humidity	0% to 95% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces
	Operating vibration	2-g peak acceleration
	Non-operating vibration	4-g peak acceleration
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
Operating system support	Windows® 7, Windows Vista, Windows XP Professional	
Approvals	UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS	

HP Wireless Keyboard and Mouse

Keyboard	Dimensions (H x L x W)	1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm)
	Weight – Without Two AA Alkaline Batteries	1.94 lb (880 g)

Technical Specifications – Keyboards and Pointing Devices

Mouse	Dimensions (H x L x W)	1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)
	Weight – Without Two AA Alkaline Batteries	0.15 lb (67 g)
Receiver	Dimensions (H x L x W)	0.33 x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)
	Weight	0.21 oz (5.9 g)
	Cable Length – Minimum	6 ft (1.8 m)
	Range	32.8 ft (10 m)
System Requirements	Windows 7 Home Basic*, Windows 7 Home Premium*, Windows 7 Professional Edition 32*, Windows 7 Professional Edition 64*, Windows 7 Ultimate Edition 32*, Windows 7 Ultimate Edition 64* Windows Vista or Windows XP Available USB port for the receiver CD-ROM Drive *This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.	
Approvals	Product Safety	UL; CSA /TUV (Europe only); CE Mark; CB Report
	Ergonomics	ANSI; ISO (Europe only); GS Mark (Germany only)
	EMC	FCC; CE; ACA (-tick); BSMI; KC ; VCCI
	CE Mark	EN 55022:2010; EN 55024; EN 301489-1; EN 61000
	Design Guidelines for PCs	PC 99 - connector overmold colors; PC 2001 - full functionality
	Telecom	All local telecom requirements and approvals for intended markets
	USA	FCC Title 47 CFR, Par 15, Subpart C; other local requirements
	Country Support	US, Belgium, Switzerland, Spain, Denmark, Netherlands, France, Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile, Argentina, Mexico, South Africa, and up to 193 countries worldwide.
Environmental	Keyboard contains 25% post-consumer recycled plastic material	

HP PS/2 Mouse

Dimensions (H x L x W)	1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)

Technical Specifications – Keyboards and Pointing Devices

Weight	3.53 oz (100g; +10g/- 5 g)	
Environmental	Operating temperature	-32° to 104°F (0° to 40° C)
	Non-operating temperature	-4° to 140°F (-20° to 60° C)
	Operating humidity	10% to 90% (non condensing at ambient)
	Non-operating humidity	10% to 90% (non condensing at ambient)
	Operating shock	40 g, 6 surfaces
	Non-operating shock	80 g, 6 surfaces
	Operating vibration	2 g peak acceleration
	Non-operating vibration	4 g peak acceleration
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
Electrical	Operating voltage	5 VDC ± 10%
	Power consumption	100mA
	System consumption	PS/2 mini-din connector
	ESD	CE level 4, 15 kV air discharge
	EMI-RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC99 - 2001	Functionally compliant
Mechanical	Resolution	800 DPI
	Tracking speed	10 in/s (25.4 cm/s) maximum
	Acceleration	±15%
	Switch actuation	65±20 gf
	Switch life	3,000,000 operations (using Hasco modified tester)
	Switch type	Low force micro-switches
	Tracking mechanism life	80 km
	Cable length	6 ft (1.8 m)
Scroll wheel	Microsoft PC99 - 2001	Mechanically compliant
	Width	6 mm
	Diameter	22.5 ± 0.2 mm
	Maximum rotation force	50 gf-cm
	Switch type	Light force micro-switch

	Switch life	1 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory Approvals	UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick	

HP USB Mouse

Dimensions (H x L x W)	1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm)
Weight	0.22 lb (0.10 kg)
Cable length	70.9 in (180 cm)
System requirements	Available USB port

HP USB 1000dpi Laser Mouse

Dimensions (H x L x W)	1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)	
Weight	3.360 oz (102g)	
Cable length	70.9 in (180 cm)	
System requirements	Available USB port	
Environmental	Operating Temperature	32° to 104° F (0° to 40° C)
	Non-operating Temperature	-4° to 140° F (-20° to 60° C)
	Operating Humidity	10% to 90% (non-condensing at ambient)
Mechanical	Resolution	1000dpi
	Tracking Speed	45 cm/sec
	Cable Length	70.9 in (180 cm)

Technical Specifications – Keyboards and Pointing Devices

HP USB PS/2 Washable Mouse

Dimensions (H x L x W)	1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)	
Weight	4.44 oz (126 g)	
Environmental	Operating temperature	–32° to 104°F (0° to 40° C)
	Non-operating temperature	–4° to 140°F (–20° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	10% to 90% non-condensing
	Operating shock	40 g, 6 surfaces
	Non-operating shock	80 g, 6 surfaces
	Operating vibration	2 g peak acceleration
	Non-operating vibration	4 g peak acceleration
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
Electrical	Operating voltage	5 VDC ± 10%
	Power consumption	100mA
	System consumption	PS/2 mini-din connector or USB
	ESD	CE level 2 8 kV air discharge
	EMI-RFI	Conforms to FCC rules for a Class B computing device
Mechanical	Microsoft® PC99 – 2001	Functionally compliant
	Resolution	1000 ± 20% DPI
	Tracking speed	14 in/s (35.56 cm/s) maximum
	Acceleration	2 g
	Switch actuation	70 g nominal peak force
	Switch life	3,000,000 operations (using Hasco modified tester)
	Switch type	Low force micro-switches
	Cable length	8.8 ft total 70 cm+ 2m extension
	Microsoft PC99 – 2001	Mechanically compliant
Scroll wheel	Width	6 mm
	Diameter	1 in (25.4 mm)
	Maximum rotation speed	48 rats/sec
	Switch type	Light force micro-switch
	Switch life	3 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory approvals	Compliant	FCC, CE Mark, ICES-003-B, IP66/NEMA4X

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range	Operating: 50° to 95° F (10° to 35° C)* Non-operating: –22° to 140° F(–30° to 60° C)
Relative Humidity	Operating: 10% to 90% (non-condensing at ambient) Non-operating: 5% to 95% (non-condensing at ambient)
Maximum Altitude (unpressurized)	Operating: 10,000 ft (3048 m) Non-operating: 30,000 ft (9144 m)

*Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	DM	SFF	TWR
Standard Efficiency	65W active PFC 87% efficient	240W active PFC	320W active PFC
80 PLUS Gold	N/A	240W active PFC	320W active PFC
		87/90/87% efficient at 20/50/100% load (115V)	87/90/87% efficient at 20/50/100% load (115V)
		89/91/90% efficient at 20/50/100% load (230V)	89/92/90% efficient at 20/50/100% load (230V)
80 PLUS Platinum	N/A	240W active PFC	320W active PFC
		90/92/89% efficient at 20/50/100% load (115V)	90/92/89% efficient at 20/50/100% load (115V)
		90/93/91% efficient at 20/50/100% load (230V)	90/94/91% efficient at 20/50/100% load (230V)
Operating Voltage Range	90 - 264 VAC	90 - 264 VAC	90 - 264 VAC
Rated Voltage Range	100 - 240 VAC	100 - 240 VAC	100 - 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency Range	47 - 63 Hz	47 - 63 Hz	47 - 63 Hz
Rated Input Current	N/A	4A	5.5A

Technical Specifications – Power

Rated Input Current with Energy Efficient* Power Supply	TBA	4A	5.5A
Current Leakage (NFPA 99)	< 250 µA	< 275 µA	<450=>275uA
Power Supply Fan		92=>70mm variable speed	92mm variable speed
Power cord length		6.0 ft. (1.83 m)	6.0 ft. (1.83 m)
External Power Adapter			
Dimensions		N/A	N/A
Total Cord Length	12 ft. 8 in	N/A	N/A

*High efficiency power supply is a requirement for ENERGY STAR® qualification in conjunction with a select range of processors and modules

Technical Specifications – Weights & Dimensions

Weights & Dimensions

(configured with 1 HDD & 1 ODD)

	DM	SFF	TWR
Chassis (W x H x D)	6.9 x 1.3 x 7.0 in 175 x 34 x 177 mm	13.3 x 3.95 x 14.9 in 338 x 100 x 379 mm	6.7 x 15.7 x 17.4 in 170 x 399 x 442 mm
System Volume	62.79 cu in 1.05 L	782.7 cu in 12.8 L	1828 cu in 30 L
System Weight	2.9 lb 1.3 kg	16.7 lb 7.6 kg	20.5 lb 9.3 kg
Max Supported Weight (desktop orientation)	N/A	77.0 lb 35.0 kg	77.0 lb 35.0 kg
Tower Stand	Pending	1.1 x 7.0 x 7.9 in 29 x 178 x 200 mm	N/A
Packaging	Pending	9.0 x 19.7 x 23.4 in 229 x 500 x 594 mm	11.6 x 19.7 x 23.2 in 295 x 500 x 590 mm
Shipping Weight	Pending	17.9 lb 8.1 kg	28.8 lb 13.1 kg
Palletization Profile	Pending	4-units per layer 10-layer max. 40-units per pallet	4-units per layer 8-layer max. 32-units per pallet

Technical Specifications – Miscellaneous Features

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
  - Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
    - 2 - processor thermal protection activated
    - 3 - processor not installed
    - 4 - power supply failure
    - 5 -- memory error
    - 6 - video error
    - 7 - PCA failure (ROM detected failure prior to video)
    - 8 - invalid ROM, bootblock recovery mode
    - 9 - system not fetching code
    - 10 - system hang while loading an option ROM
- HP PC Hardware Diagnostics UEFI:
  - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacemen
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED - To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification

Technical Specifications – Miscellaneous Features

Additional Features	Description
Towerable Orientation	Product can be oriented as either a desktop or a tower
Drive Lock	Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.
	DPS Access through F10 Setup during Boot
	A diagnostic hard drive self test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user
Drive Protection System	Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced
	The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures
SMART Technology (Self-Monitoring, Analysis and Reporting Technology)	Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted
SMART I - Drive Failure Prediction	Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count
SMART II - Off-Line Data Collection	By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure
SMART III - Off-Line Read Scanning with Defect Reallocation	IOEDC: I/O Error Detection Circuitry
	Detects errors in Read/Write buffers on HDD cache RAM
SMART IV - End-to-End CRC for hard drives	Interface in F10 setup provides confirmation of SMART IV support.

Environmental Data

Eco-Label Certifications & Declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.

*__NOTE:__ This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.

Small Form Desktop

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Small Form Factor model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Energy Consumption (in accordance with US ENERGY STAR® test method)

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	21.00 W	21.05 W	21.42 W
Sleep	1.42 W	1.50 W	1.42 W
Off	0.50 W	0.57 W	0.50 W

NOTE:
Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	72 BTU/hr	72 BTU/hr	73 BTU/hr
Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
Off	2 BTU/hr	2 BTU/hr	2 BTU/hr

*__NOTE:__ Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Typically Configured - Idle	3.6	26
Fixed Disk - Random writes	3.6	26

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 10 externally accessible USB ports

- 4 DIMM memory slots
- 1 PCI Express x16 graphics slot
- 3 PCI Express x1 accessory slots
- 1 3.5" internal storage drive bays
- 1 2.5" internal storage drive bay
- 1 3.5" Media Card Reader bay (could also support an internal storage drive)
- 1 external slim optical drive bay

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the1ppm by weight
- Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)
Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 14.8 % post-consumer recycled plastic (by wt.)
- This product is 94.1 % recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
  - PAPER/Corrugated 2300 g
- Internal:
  - PLASTIC/Polyethylene low density 56 g
  - PLASTIC/EPE-Expanded Polyethylene 110 g
  - PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated packaging material contains at least 38.4 % recycled content.
- The PLASTIC/Polyethylene low density packaging material contains at least 60.4% recycled content.
- The PLASTIC/EPE-Expanded Polyethylene packaging material contains at least 60.4% recycled content.
- The PLASTIC/Polyethylene packaging material contains at least 60.4 % recycled content.

Technical Specifications – Environmental Data

Tower

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Tower model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Energy Consumption (in accordance with US ENERGY STAR® test method)

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	22.49 W	23.72 W	22.22 W
Sleep	1.42 W	1.50 W	1.39 W
Off	0.47 W	0.56 W	0.46 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	77 BTU/hr	81 BTU/hr	76 BTU/hr
Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
Off	2 BTU/hr	2 BTU/hr	2 BTU/hr

***NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Typically Configured - Idle	3.6	26
Fixed Disk - Random writes	3.6	26

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 10 externally accessible USB ports
- 4 DIMM memory slots
- 1 PCI Express x16 graphics slot
- 3 PCI Express x1 accessory slots
- 2 3.5" internal storage drive bays
- 1 2.5" internal storage drive bay
- 1 3.5" Media Card Reader bay
- 1 external slim optical drive bay
- 1 external 5.25" half height optical drive bay

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the1ppm by weight
- Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)
Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 15 % post-consumer recycled plastic (by wt.)
- This product is 95.5 % recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
  - PAPER/Corrugated 2280 g
- Internal:
  - PLASTIC/EPE (Expanded Polyethylene) 40 g
  - PLASTIC/Polyethylene low density 144 g
  - PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated packaging material contains at least 53.5 % recycled content
- The PLASTIC/Polyethylene low density packaging material contains at least 60.42 % recycled content
- The PLASTIC/EPE-Expanded Polyethylene packaging material contains at least 60.42 % recycled content.
- The PLASTIC/Polypropylene packaging material contains at least 60.42 % recycled content.

Common to all Form Factors

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants - may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel - finishes must not be used on the external surface designed to be frequently handled

or carried by the user.

- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) - except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report
http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
Eco-label certifications
http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
ISO 14001 certificates:
http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf
and
http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

Options and Accessories (sold separately)

Communication Devices

	DM	SFF/TWR	Part Number
Intel Ethernet I210 - T1 Gbe NIC		X	E0X95AA
Intel 6205 802.11 a/b/g/n PCIe x1 NIC		X	E0X93AA

NOTE: The use of any of these optional NIC Cards (wired or wireless) will disable the Intel vPro Technology features.

Graphics Solutions

	DM	SFF/TWR	Part Number
AMD Radeon HD 8350 Graphics (PCIe x16)		X	E1C63AA
AMD Radeon HD 8490 Graphics Card		X	E1C64AA
Nvidia NVS 310 Graphics (PCIe x16)		X	A7U59AA
Nvidia NVS 315 Graphics (PCIe x16)		X	E1C65AA
HP USB Graphic Adapter		X	NL571AA
HP DisplayPort Cable Kit	X	X	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	X	X	NR078AA
HP DisplayPort To DVI-D Adapter	X	X	FH973AA
HP DisplayPort to HDMI Adapter	X	X	BP937AA
HP DisplayPort to VGA Adapter	X	X	AS615AA
HP DMS-59 to Dual DVI Cable		X	DL139A
HP DMS-59 to Dual DisplayPort Adapter		X	XP688AA

Data Storage Drives and Accessories

	DM	SFF/TWR	Part Number
HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		X	QK554AA
HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		X	QK555AA
HP 128-GB SATA 3.0Gb/s Solid State Drive	X	X	QV063AA
HP 128-GB SED Opal 2 Solid State Drive	X		G1K24AA
HP 160-GB SATA 3.0Gb/s Solid State Drive	X	X	QV064AA*
HP 500-GB SATA 3.0Gb/s Solid State Hybrid Drive	X	X	E1C62AA
HP Slim Removable SATA Hard Drive Enclosure (frame & carrier)		X	C1N41AA
HP Slim Removable SATA Hard Drive Enclosure (carrier only)		X	E3F39AA
HP Chassis (1bay) Security Kit		TWR only	AR639AA

*Not available in all regions.

Options and Accessories (sold separately)

Input Devices	DM	SFF/TWR	Part Number
HP USB Keyboard	X	X	QY776AA
HP USB Gray Keyboard	X	X	B6B64AA
HP USB Smart Card (CCID) Keyboard	X	X	BV813AA
HP USB Keyboard and Mouse Kit	X	X	B1T09AA
HP USB Washable Keyboard	X	X	VF097AA
HP USB and PS/2 Washable Mouse	X	X	BM866AA
HP USB and PS/2 Washable Keyboard and Mouse Kit	X	X	BU207AA
HP PS/2 Mouse	X	X	QY775AA
HP USB Mouse	X	X	QY777AA
HP USB 1000dpi Laser Mouse	X	X	QY778AA
HP Wireless Keyboard and Mouse Combination*	X	X	QY449AA
*Keyboard contains 25% post-consumer recycled plastic material			

System Memory	DM	SFF/TWR	Part Number
HP 4GB DDR3-1600 (PC3-12800) DIMM		X	B4U36AA
HP 8GB DDR3-1600 (PC3-12800) DIMM		X	B4U37AA
HP 4GB DDR3-1600 (PC3-12800) SODIMM	X		B4U39AA
HP 8GB DDR3-1600 (PC3-12800) SODIMM	X		B4U40AA

Multimedia Devices	DM	SFF/TWR	Part Number
HP Slim DVD-ROM Drive		X	VP033AA
HP Slim SuperMulti DVD Writer Drive		X	QS209AA
HP USB HD 720P v2 Business Webcam	X	X	D8Z08AA
HP Business Headset	X	X	QK550AA
HP USB Business Speakers	X	X	D9J19AA

Removable Media Storage	DM	SFF/TWR	Part Number
HP 14-n-1 Media Card Reader (available Dec. 2013)		X	TBD

Security Devices	DM	SFF/TWR	Part Number
HP Solenoid Lock and Hood Sensor (SFF)		SFF only	E0X97AA
HP Solenoid Lock and Hood Sensor (TWR)		TWR only	E0X96AA
HP SFF Wall Mount/Security Sleeve		SFF only	VN570AA
HP UltraSlim Cable Lock	X	X	H4D73AA
HP DM Security Sleeve	X		G1K22AA

Options and Accessories (sold separately)

Stands and Accessories	DM	SFF/TWR	Part Number
HP Integrated Work Center Stand (DM)	X		Pending
HP Integrated Work Center Stand (SFF)		SFF only	QP897AA
HP SFF Tower Stand		SFF only	VN569AA
HP DM Chassis Tower Stand	X		G1K23AA
HP DM Rack Mount Shelf	X		G1K21AA
HP 600/800 Tower Bezel Kit		TWR only	E1C66AA
HP 800/600 SFF Bezel Kit		SFF only	E3F27AA
HP Serial Port Adapter (RS-232 compatible)		X	PA716A
HP Parallel Port Kit		X	KD061AA
Belkin USB to Serial Adapter	X		EM449AA

LANDesk Software (E-Delivery)	Part Number
LANDesk Management Suite License - 1-499 Nodes E-Delivery	QY369AAE
LANDesk Management Suite License - 500-999 Nodes E-Delivery	QY370AAE
LANDesk Management Suite License - 1000-1999 Nodes E-Delivery	QY371AAE
LANDesk Management Suite License - 2000-4999 Nodes E-Delivery	QY372AAE
LANDesk Management Suite License - 5000-9999 Nodes E-Delivery	QY373AAE
LANDesk Security Suite License E-Delivery	QY379AAE
LANDesk Management Suite 1 Year Maintenance - 1-499 Nodes E-Delivery	HZ825AAE
LANDesk Management Suite 1 Year Maintenance - 500-999 Nodes E-Delivery	HZ826AAE
LANDesk Management Suite 1 Year Maintenance - 1000-1999 Nodes E-Delivery	HZ827AAE
LANDesk Management Suite 1 Year Maintenance - 2000-4999 Nodes E-Delivery	HZ828AAE
LANDesk Management Suite 1 Year Maintenance - 5000-9999 Nodes E-Delivery	HZ829AAE
LANDesk Security Suite 1 Year Subscription	HZ830AAE
LANDesk Patch Management 1 Year Subscription - 1-499 Nodes E-Delivery	HZ831AAE
LANDesk Patch Management 1 Year Subscription - 500-999 Nodes E-Delivery	HZ832AAE
LANDesk Patch Management 1 Year Subscription - 1000-1999 Nodes E-Delivery	HZ833AAE
LANDesk Patch Management 1 Year Subscription - 2000-4999 Nodes E-Delivery	HZ834AAE
LANDeskPatch Management 1 Year Subscription - 5000-9999 Nodes E-Delivery	HZ835AAE
LANDeskPatch Management 1 Year Subscription - 5000-9999 Nodes E-Delivery	HZ835AAE

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